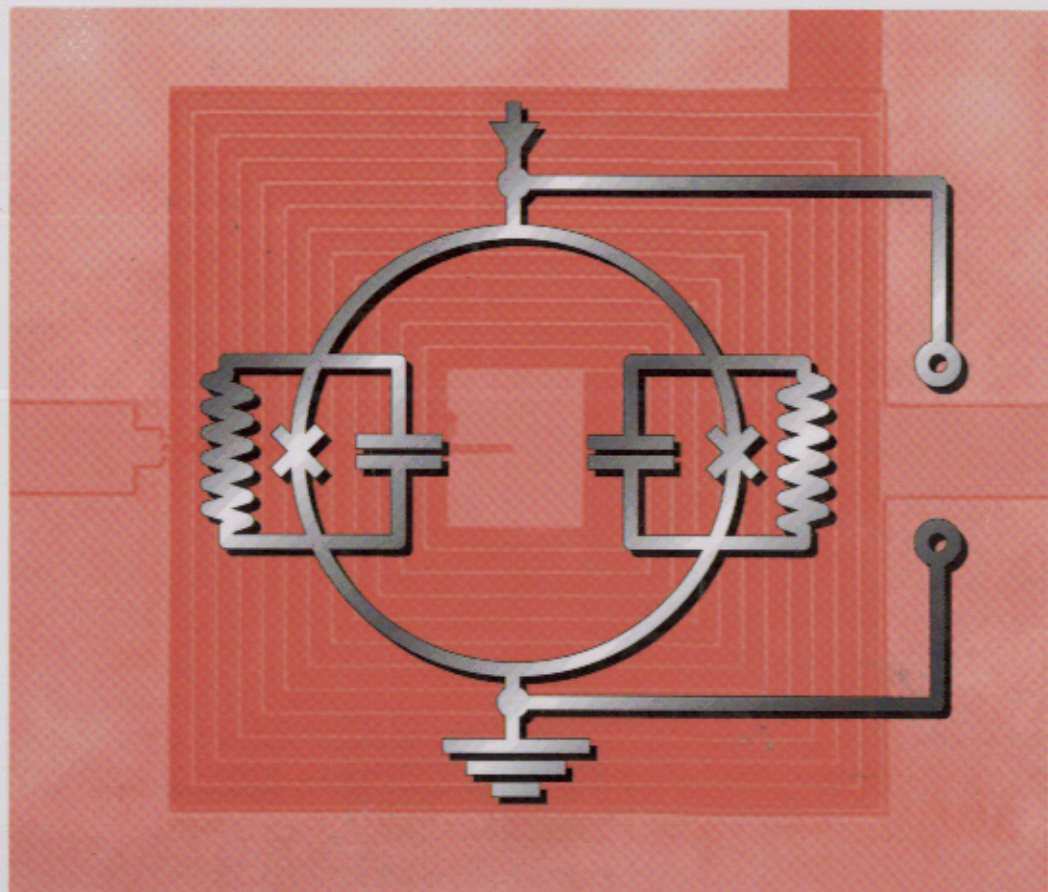


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The SQUID Handbook

Vol. I Fundamentals and Technology of SQUIDs
and SQUID Systems



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